fibreglass reinforced



TFO-XS-SI is a high performance electrically insulating thermally conductive silicone foil for an optimised thermal coupling between electronic packages and heat sinks. Through the specific formulation and filling with highly thermally conductive ceramic particles an excellent thermal conductivity is reached. Its conformal surface structure guarantees a very good compliance to the contact surfaces. Thus the total thermal resistance is minimised. The fibreglass reinforcement provides for an outstanding mechanic stability and cutthrough resistance as well as easy handling. For an easy and reliable

preassembly the interface material is available with low tack pressure sensitive adhesive on one side.



Release 02/202

Technical Data Sheet

PROPERTIES

- Thermal conductivity: 5.0 W/mK
- High surface compliance and flexibility
- Excellent thermal contact
- Outstanding mechanic stability through fibreglass reinforcement
- Extraordinary chemical resistance and longterm stability
- Residue-free removal after use

AVAILABILITY

- Non tacky Sheet 320 x 440 mm (TF0-XSXXX-SI)
- ☐ Tacky on one side Sheet 200 x 260 mm (TFO-XSXXX-SI-A1)
- Die cut parts
- Kiss cut parts on sheet

APPLICATION EXAMPLES

Thermal link of:

- MOSFETs or IGBTs
- Power diodes or AC/DC converters
- Power modules

For use in Switch mode power supplies / Motor control units / Automotive engine management systems / UPS units / Solar systems

PROPERTY	UNIT	TF0-XS200-SI	TF0-XS300-SI	TF0-XS450-SI
MATERIAL		Ceramic filled silicone	Ceramic filled silicone	Ceramic filled silicone
Colour		White	White	White
Reinforcement		Fibreglass	Fibreglass	Fibreglass
Thickness	mm	0.20 ±0.05	0.30 + 0.10	0.45 ±0.05
Tensile Strength ¹	kpsi	7.4	7.1	2.0
UL Flammability	UL 94	V0	V0	V0
RoHS Conformity	2015 / 863 / EU	Yes	Yes	Yes
THERMAL				
Resistance ² @ 150 PSI	°C-inch²/W	0.13	0.22	0.31
Resistance ² @ 30 PSI	°C-inch²/W	0.30	0.37	0.46
Thermal Conductivity²	W/mK	5.0	5.0	5.0
Operating Temperature Range	°C	- 40 to + 180	- 40 to + 180	- 40 to + 180
ELECTRICAL				
Breakdown Voltage³	kV AC	2	5	7
Volume Resistivity	0hm - cm	0.8 x 10 ¹⁵	1.0 x 10 ¹⁵	0.9 x 10 ¹⁵
Dielectric Constant	@ 1 MHz	3.0	3.1	2.9

Measurement technique according to: ASTM D 412, ASTM D 5470, ASTM D 149. All data without warranty and subject to change. Please contact us for further data and information. Shelf life adhesive: 6 months when stored in original packaging at room temperature and 50% relative humidity.

Thicknesses: 0.20 mm / 0.30 mm / 0.45 mm / 0.80 mm

